

Low frequency transistor (12V, 500mA)

Datasheet

(3)

2SC5585E3

(EMT3)

SOT-416

Parameter	Value
V _{CEO}	12V
Ι _C	500mA

Features

1)High current.

2)Low V_{CE(sat)}

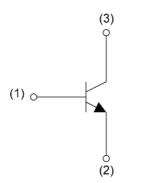
V_{CE(sat)}≦250mV at I_C=200mA/I_B=10mA

Application

LOW FREQUENCY AMPLIFIER, DRIVER

Inner circuit

2SC5663



(1) Base
(2) Emitter
(3) Collector

2SC5585E3

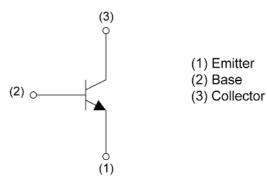
Outline

SOT-723

(3)

2SC5663

(VMT3)



Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
2SC5663	SOT-723 (VMT3)	1212	T2L	180	8	8000	BX
2SC5585E3	SOT-416 (EMT3)	1616	TL	180	8	3000	BX

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter			Values	Unit
Collector-base voltage			15	V
Collector-emitter voltage			12	V
Emitter-base voltage			6	V
Collector current		Ι _C	500	mA
		I _{CP} *1	1.0	Α
Power dissipation 2SC5663 2SC5585E3		D *2	150	
			150	mW
Junction temperature	Tj	150	°C	
Range of storage tempera	T _{stg}	-55 to +150	°C	

• Electrical characteristics (T_a = 25°C)

Deremeter	Cumbal	Conditions	Values			1.1
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	_D I _C = 10μA		-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	12	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = 10μΑ	6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 15V	-	-	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 6V	-	-	100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 200mA, I _B = 10mA	-	90	250	mV
DC current gain	h _{FE}	V _{CE} = 2V, I _C = 10mA	270	-	680	-
Transition frequency	f _T	V _{CE} = 2V, I _E = -10mA, f = 100MHz	-	320	-	MHz
Output capacitance	C _{ob}	V _{CB} = 10V, I _E = 0A, f = 1MHz	-	7.5	-	pF

*1 Pw=1ms, Single Pulse.

*2 Each terminal mounted on a reference land.



• Electrical characteristic curves ($T_a = 25^{\circ}C$)

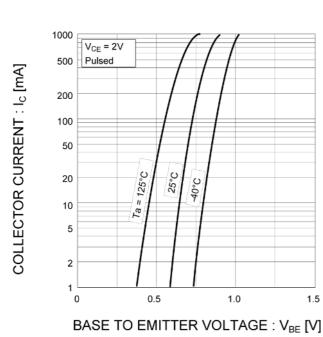


Fig.1 Ground Emitter Propagation Characteristics

I_B= 700 μA 600 μA 200 500 PA 180 COLLECTOR CURRENT : I_c [mA] 160 400 HA 140 300 µA 120 100 80 200 µA 60 100 µA 40 Ta = 25°C 20 Pulsed 0 0.5 0 1 1.5 2

Fig.2 Typical Output Characteristics

COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

DC CURRENT GAIN : hFE

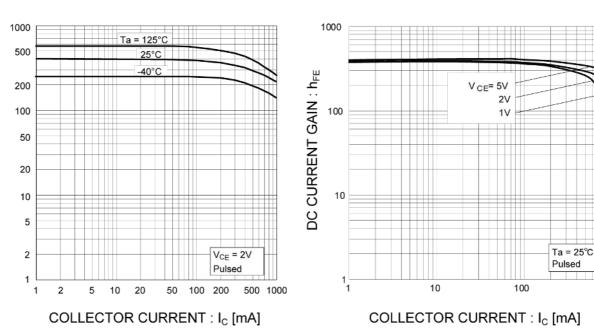


Fig.4 DC Current Gain vs. Collector Current (II)





1000

• Electrical characteristic curves($T_a = 25^{\circ}C$)

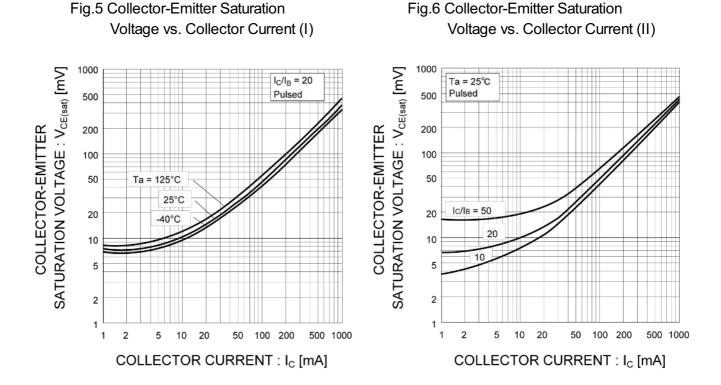


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

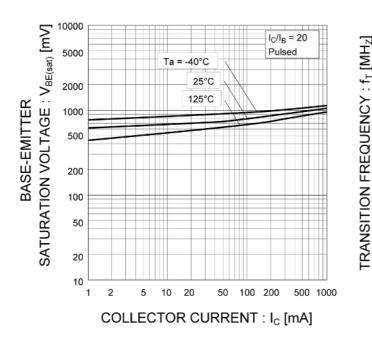
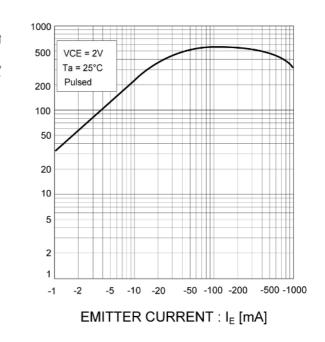


Fig.8 Gain Bandwidth Product vs. Emitter Current



● Electrical characteristic curves(T_a = 25°C)

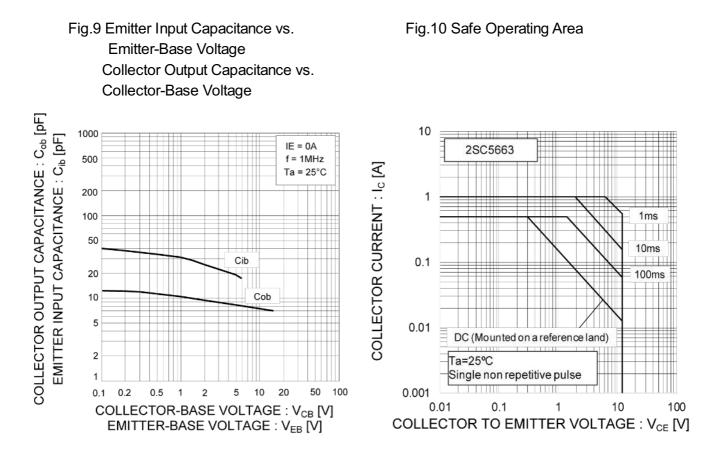
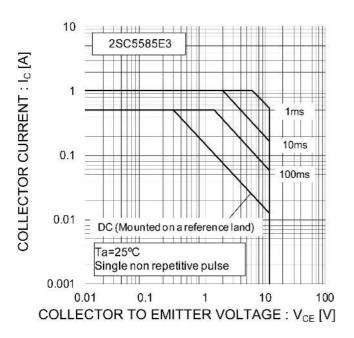


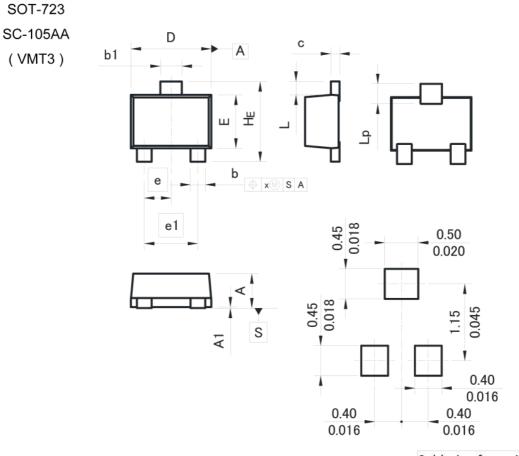
Fig.11 Safe Operating Area



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Dimensions



Soldering footprint

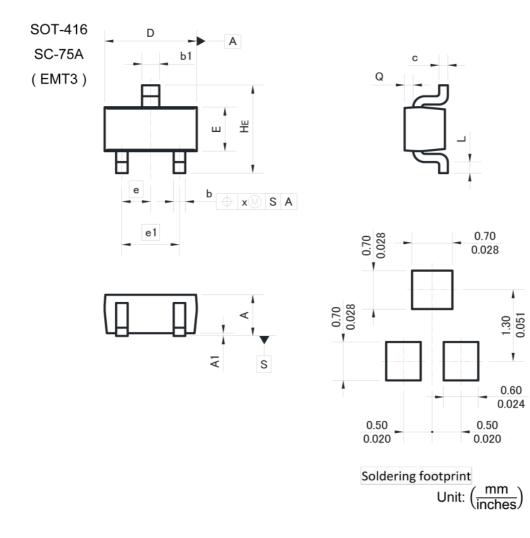
Init:	<i>ι</i> ι	
Jnil.	(inches)	

DIM	Millim	ieters	Inches		
	Min.	Max.	Min.	Max.	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
b1	0.27	0.37	0.011	0.015	
С	0.08	0.18	0.003	0.007	
D	1.10	1.30	0.043	0.051	
E	0.70	0.90	0.028	0.035	
е	0.40		0.016		
e1	0.80		0.0	31	
HE	1.10	1.30	0.043	0.051	
L	0.10	0.30	0.004	0.012	
Lp	0.20	0.40	0.008	0.016	
х	-	0.10	-	0.004	

Dimension in mm / inches



Dimensions



DIM	Millim	neters	Inches	
	Min.	Max.	Min.	Max.
Α	0.60	0.90	0.024	0.035
A1	0.00	0.10	0.000	0.004
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.50		0.020	
e1	1.00		0.0	39
HE	1.40	1.80	0.055	0.071
L	0.10	-	0.004	-
Q	0.05	0.25	0.002	0.010
x	_	0.10	-	0.004

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the S	pecific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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